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Common-mode EMI filter for differential channels with integrated ESD protection

Rev. 2 — 28 April 2014

Product data sheet

1. Product profile

1.1 General description

The devices are common-mode ElectroMagnetic Interference (EMI) filters with integrated ElectroStatic Discharge (ESD) protection for two and three differential channels. The devices are designed to provide low insertion loss for differential high-speed signals on each channel while unwanted common-mode signals are attenuated.

Each differential channel incorporates two signal lines that are coupled by integrated coils. Diodes provide protection to downstream components from ESD voltages up to ± 15 kV on each signal line.

Table 1. Product overview

Type number		Package		
	channels	Name	Version	
PCMF2DFN1	2	DFN2520-9	SOT1333-1	XSON9
PCMF3DFN1	3	DFN4020-14	SOT1334-1	XSON14

1.2 Features and benefits

- Two and three differential channels common-mode EMI filter with integrated ESD protection
- Superior common-mode suppression over a wide frequency range

1.3 Applications

- Smartphone, cellular and cordless phone
- MIPI D-PHY as used in Camera Serial Interface (CSI) and Display Serial Interface (DSI)
- General-purpose EMI and Radio-Frequency Interference (RFI) filter and downstream ESD protection

- ESD protection up to ±15 kV contact discharge according to IEC 61000-4-2
- Maximum package height: 0.5 mm
- Tablet PC and Mobile Internet Device (MID)
- High-Definition Multimedia Interface (HDMI)



Common-mode EMI filter for differential channels with ESD protection

2. Pinning information

Table :	2. Pinning			
Pin	Symbol	Description	Simplified outline	Graphic symbol
PCMF	2DFN1 (SOT1333	3-1)		
1	CH1_IN+	input channel 1		
2	CH1_IN-	input channel 1	1 9	
3	GND	ground	2 8	20
4	CH2_IN+	input channel 2	3	
5	CH2_IN-	input channel 2	4 7	本 卒
6	CH2_OUT-	output channel 2	5 6	
7	CH2_OUT+	output channel 2	Turnerstein	÷ 3
8	CH1_OUT-	output channel 1	Transparent top view DFN2520-9	47
9	CH1_OUT+	output channel 1	DFN2520-9	56
				주 주
PCMF	3DFN1 (SOT1334	4-1)		1
1	CH1_IN+	input channel 1		
2	CH1_IN-	input channel 1	1 14	
3	GND_1	ground 1	2 13	2 13
4	CH2_IN+	input channel 2	3	
5	CH2_IN-	input channel 2	4 12	平 平
6	GND_2	ground 2	5 11	
7	CH3_IN+	input channel 3	6	 3
8	CH3_IN-	input channel 3	7 10	4 12
9	CH3_OUT-	output channel 3	8 9	
10	CH3_OUT+	output channel 3	Tanana kana sian	
11	CH2_OUT-	output channel 2	Transparent top view	
12	CH2_OUT+	output channel 2	DFN4020-14	
13	CH1_OUT-	output channel 1		
14	CH1_OUT+	output channel 1		
				7 10
				8 9
				本 本
				aaa-007384

PCMF2DFN1_PCMF3DFN1

Common-mode EMI filter for differential channels with ESD protection

3. Ordering information

Table 3. Ordering information								
Type number	Package	kage						
	Name	Description	Version					
PCMF2DFN1	DFN2520-9	plastic extremely thin small outline package; no leads; 9 terminals; body $2 \times 2.5 \times 0.5$ mm	SOT1333-1					
PCMF3DFN1	DFN4020-14	plastic extremely thin small outline package; no leads; 14 terminals; body $2 \times 4 \times 0.5$ mm	SOT1334-1					

4. Marking

Table 4. Marking codes	
Type number	Marking code
PCMF2DFN1	MP1
PCMF3DFN1	CMFMP1

5. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
VI	input voltage		-0.5	5	V
V _{ESD} electrostatic disc voltage	electrostatic discharge voltage	IEC 61000-4-2, level 4; all input pins to ground			
		contact discharge	-15	15	kV
		air discharge	-15	15	kV
		IEC 61000-4-2, level 4; all output pins to ground			
		contact discharge	-2	2	kV
		air discharge	-2	2	kV
T _{stg}	storage temperature		-55	+125	°C
T _{amb}	ambient temperature		-40	+85	°C

Common-mode EMI filter for differential channels with ESD protection

6. Characteristics

6.1 Channel characteristics

Table 6. Channel characteristics

 $T_{amb} = 25 \ ^{\circ}C$ unless otherwise specified.

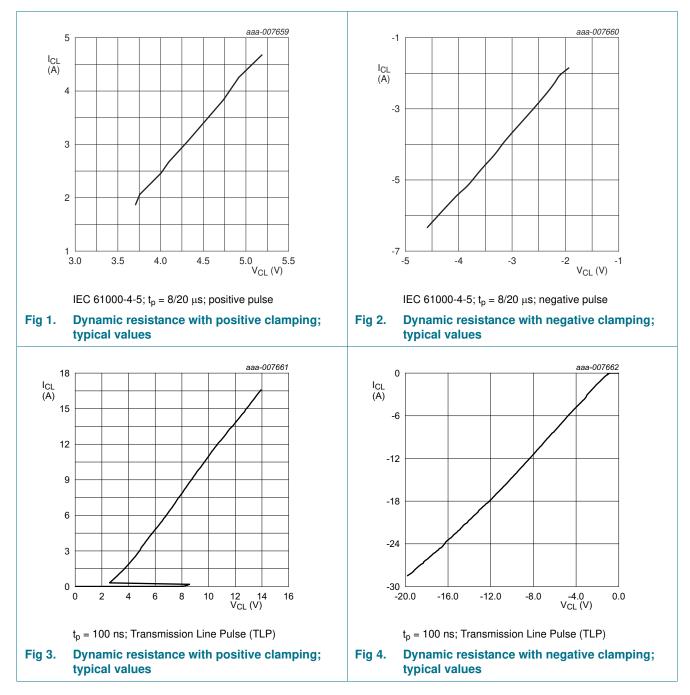
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$R_{s(ch)}$	channel series resistance	single line; input to output		5	-	Ω
C _d	diode capacitance	f = 1 MHz; V _I = 2.5 V [1]	-	0.6	0.75	pF
I _{RM}	reverse leakage current	per line; V _I = 5 V	-	-	100	nA
V _{BR}	breakdown voltage	I _R = 10 mA	6	-	9	V
V _F	forward voltage	I _F = 10 mA	0.6	-	1.1	V
R _{dyn}	dynamic resistance	TLP [2]				
		positive transient	-	0.6	-	Ω
		negative transient	-	0.6	-	Ω
		surge [3]				
		positive transient	-	0.6	-	Ω
		negative transient	-	0.6	-	Ω
V _{CL}	clamping voltage	positive transient; $I_{PP} = 4 A$ [3]	-	4.8	-	V
		negative transient; $I_{PP} = -5 A$ [3]	-	-3.6	-	V
		TLP; I _{CL} = 8 A	-	8	-	V
		TLP; I _{CL} = 12 A	-	10.5	-	V
		TLP; I _{CL} = 16 A	-	13.4	-	V
		TLP; $I_{CL} = -8 \text{ A}$	-	-6	-	V
		TLP; I _{CL} = -12 A	-	-8.4	-	V
		TLP; I _{CL} = -16 A	-	-10.7	-	V

[1] This parameter is guaranteed by design.

[2] 100 ns Transmission Line Pulse (TLP); 50 Ω ; pulser at 70 to 90 ns.

[3] According to IEC 61000-4-5 (8/20 $\mu s).$

Common-mode EMI filter for differential channels with ESD protection



The device uses an advanced clamping structure showing a negative dynamic resistance. This snap-back behavior strongly reduces the clamping voltage to the system behind the ESD protection during an ESD event. Do not connect unlimited DC current sources to the data lines to avoid keeping the ESD protection device in snap-back state after exceeding breakdown voltage (due to an ESD pulse for instance).

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Common-mode EMI filter for differential channels with ESD protection

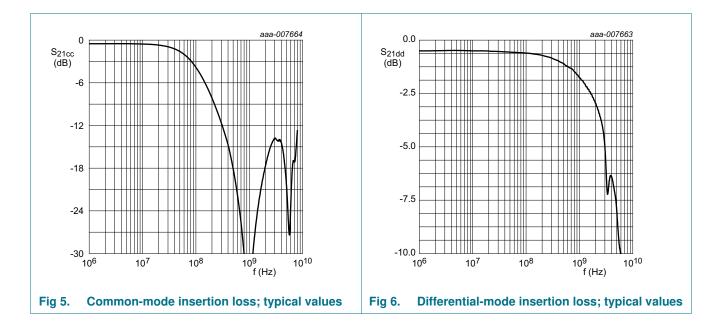
6.2 Frequency characteristics

Table 7. Frequency characteristics

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
Commor	n mode: S _{21cc}						
α_{il}	insertion loss		[1]				
		f = 400 MHz		-	15	-	dB
		f = 800 MHz		-	30	-	dB
		f = 5 GHz		-	21	-	dB
Different	tial mode: S _{21dd}						
α_{il}	insertion loss	f = 1MHz	[1]	-	0.6	-	dB
f _{-3dB}	cut-off frequency		[1][2]	-	2.2	-	GHz

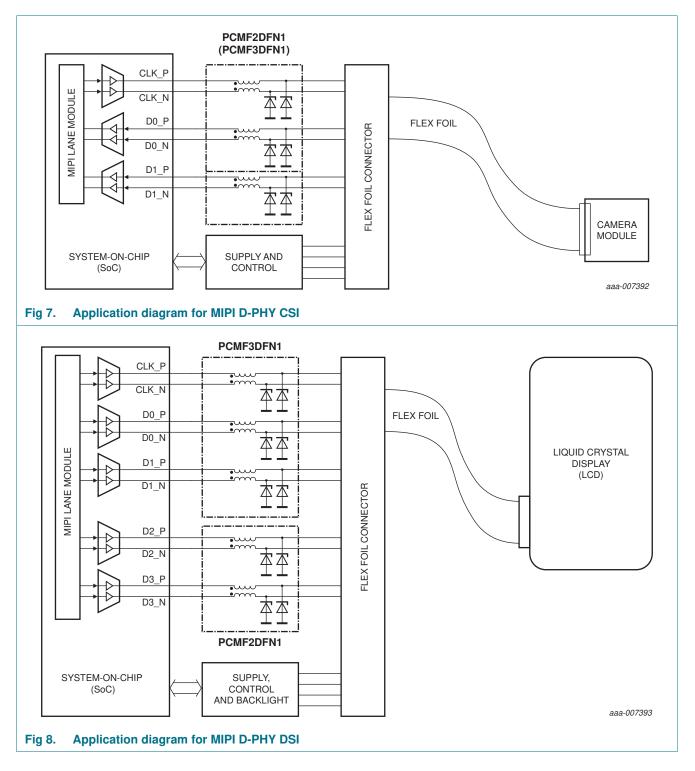
[1] Measured with 4-port network analyzer; R_{gen} = 50 Ω ; R_L = 50 Ω .

[2] Normalized to attenuation at 1 MHz.



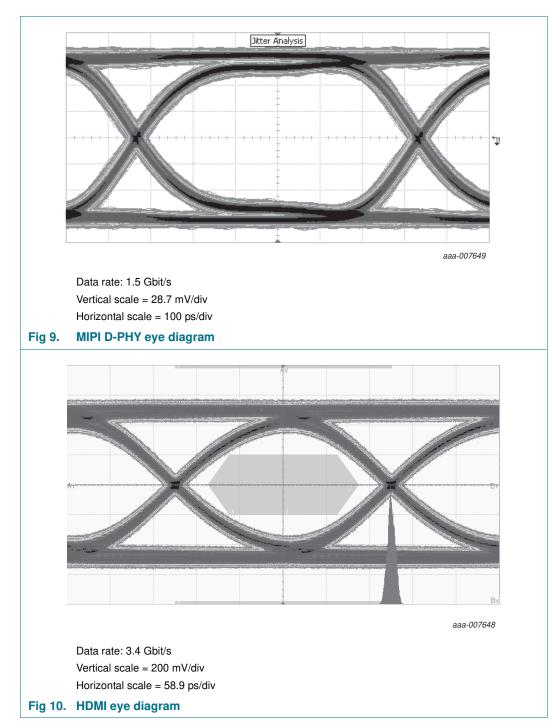
Common-mode EMI filter for differential channels with ESD protection

7. Application information



7.1 Application diagram

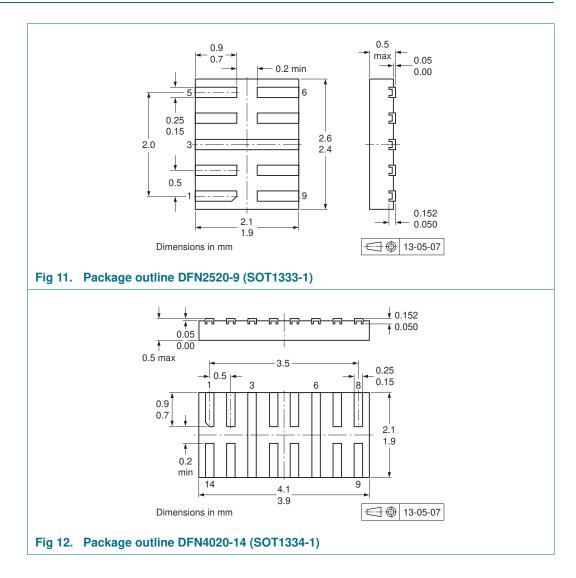
Common-mode EMI filter for differential channels with ESD protection



7.2 Eye diagram

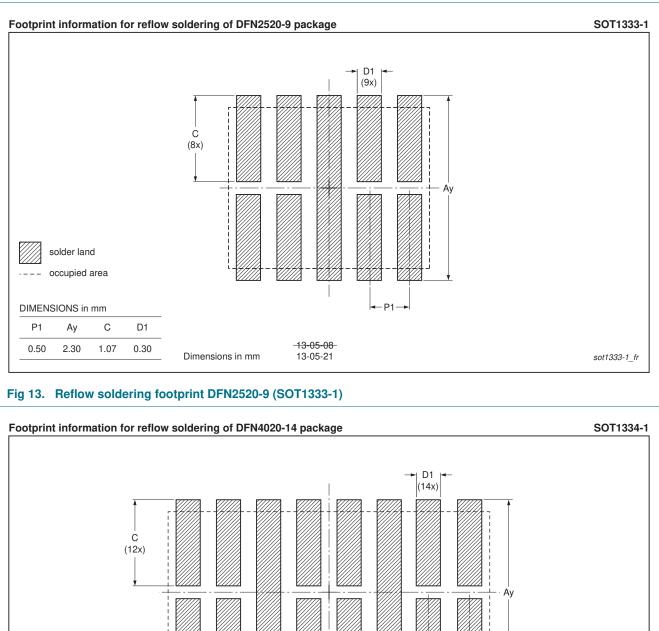
Common-mode EMI filter for differential channels with ESD protection

8. Package outline



Common-mode EMI filter for differential channels with ESD protection

9. Soldering



solder land occupied area DIMENSIONS in mm P1-P1 D1 Ay С 13-05-08 0.50 2.30 1.07 0.30 Dimensions in mm 13-05-21 sot1334-1_fr

Fig 14. Reflow soldering footprint DFN4020-14 (SOT1334-1)

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Common-mode EMI filter for differential channels with ESD protection

10. Revision history

Table 8.Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes	
PCMF2DFN1_PCMF3DFN1 v.2	20140428	Product data sheet	-	PCMF2DFN1_PCMF3DFN1 v.1	
Modification:	Surge rating adapted				
PCMF2DFN1_PCMF3DFN1 v.1	20130606	Product data sheet	-	-	

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Common-mode EMI filter for differential channels with ESD protection

11. Legal information

11.1 Data sheet status

Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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Product [short] data sheet	Production	This document contains the product specification.

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Common-mode EMI filter for differential channels with ESD protection

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